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REV.	ECN.NO.	APPD.
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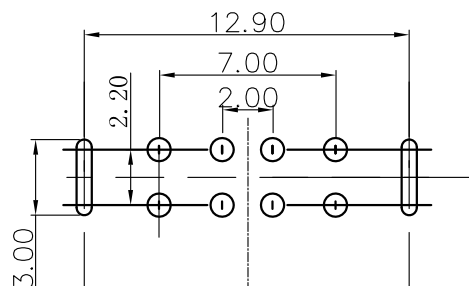
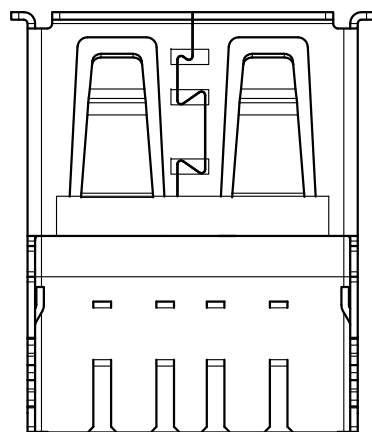
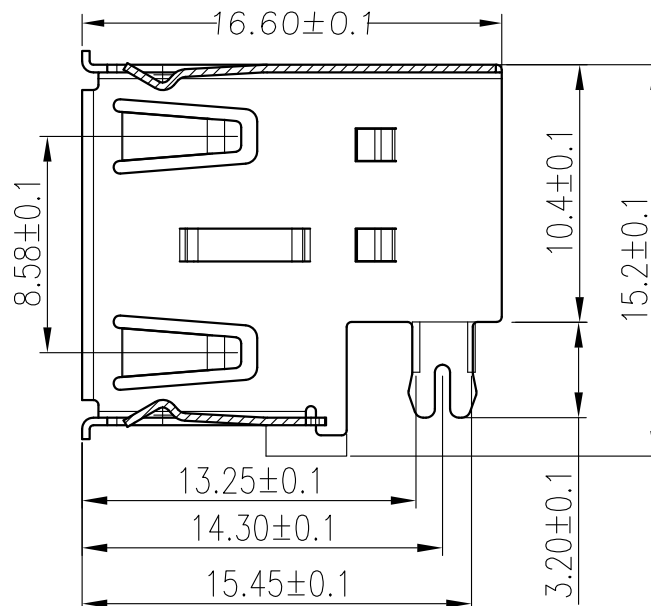
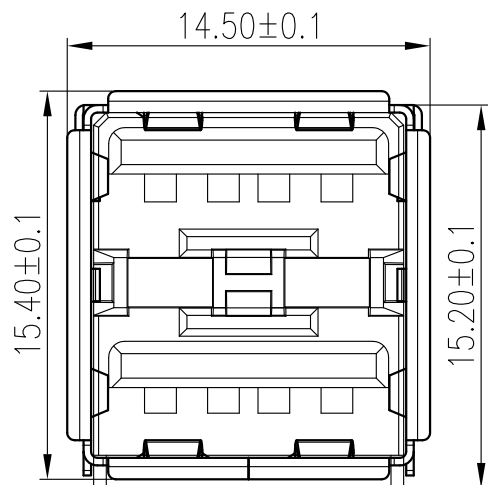
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NOTES:

1.MATERIAL:

1.1 Housing:thermoplastic plastics

1.2 terminals:Copper Alloy

Gold plated in contact area:

Tin plated in termination

Nickel Plated overall

1.3 Shell:Steel&Copper Alloy

Nickel Plated overall

2.ELECTRICAL CHARACTERISTICS:

2.1 Rating Current :1.5 Ampere

2.2 Rating Voltage :30 V Max

2.3 Contact Resistance:30 Milli ohms

2.4 Insulation Resistance:1000 Mega ohms Min.

3.MECHANICAL CHARACTERISTICS:

3.1 Connector Mating force: 35N MAX(3.57Kgf)

3.2 Connector Unmating force:10N min(1.02Kgf)

3.3 Durability:1500Cycles.

4.ENVIRONMENT CHARACTERISTICS:

4.1 Operating temperature:-0°C to +50°C

4.2 Storage temperature:-20°C to +60°C

U221-J931-G27017

1:铁壳镀镍

1:吸塑盒

G:半金G/Fu"

2:PBT

7:蓝色

TOLERANCE UNLESS OTHERWISE SPECIFIED		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.;LTD.			
.XXX ±0.10	.X' ±3'	HLW 深圳市华联威电子科技有限公司 HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.;LTD.			
.XX ±0.20	.XX' ±2'				
.X ±0.30					
APPROVED		PART NAME:	USB AF 90度双层沉板10.5		
CHECKED		PART No:	U221-J931-G27017	C	
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET
DATE	2022.03.30		mm	1:1	1 OF 1
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